Advanced Semiconductor Engineering, Inc.



FOR IMMEDIATE RELEASE

Contact: ASE, Inc. Joseph Tung, CFO / Vice President Allen Kan, Director Tel: +886-2-6636-5678 Fax: +886-2-2757-6121 ir@aseglobal.com http://www.aseglobal.com

US contact: Clare Lin, Senior Director Tel: +1-408-636-9524 clare.lin@aseus.com

ADVANCED SEMICONDUCTOR ENGINEERING, INC. ANNOUNCES MONTHLY NET REVENUES

TAIPEI, TAIWAN, R.O.C., APRIL 9, 2012 – ADVANCED SEMICONDUCTOR ENGINEERING, INC. (NYSE: ASX, TAIEX: 2311, "ASE" or the "Company"), announces its unaudited consolidated net revenues for March and 1st quarter of 2012.

CONSOLIDATED NET REVENUES (UNAUDITED)

	Mar	Feb	Mar	Sequential	YoY
(NT\$ Million)	2012	2012	2011	Change	Change
Net Revenues	15,365	14,180	16,527	+8.4%	-7.0%
	Mar	Feb	Mar	Sequential	YoY
(US\$ Million)	2012	2012	2011	Change	Change
Net Revenues	521	479	560	+8.8%	-6.9%
	Q1	Q4	Q1	Sequential	YoY
(NT\$ Million)	2012	2011	2011	Change	Change
Net Revenues	43,101	46,390	46,005	-7.1%	-6.3%
	Q1	Q4	Q1	Sequential	YoY
(US\$ Million)	2012	2011	2011	Change	Change
Net Revenues	1,450	1,534	1,570	-5.5%	-7.6%

Starting from Feb. 1, 2010, Universal Scientific Industrial Co., Ltd.'s consolidated revenues were consolidated into ASE Inc.'s consolidated revenues. Net revenues for the ATM assembly test and material business (excluding USI) are as follows:

ATM NET REVENUES (UNAUDITED)

(NT\$ Million)	Mar 2012	Feb 2012	Mar 2011	Sequential Change	YoY <u>Change</u>
Net Revenues	10,405	9,488	10,995	+9.7%	-5.4%
	Mar	Feb	Mar	Sequential	YoY
(US\$ Million)	2012	2012	2011	Change	<u>Change</u>
Net Revenues	353	320	373	+10.1%	-5.3%

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Q1	Q4	Q1	Sequential	YoY
2012	2011	2011	Change	Change
29,236	31,908	30,879	-8.4%	-5.3%
Q1	Q4	Q1	Sequential	YoY
2012	2011	2011	Change	Change
984	1,055	1,054	-6.8%	-6.7%
	2012 29,236 Q1 2012	2012 2011 29,236 31,908 Q1 Q4 2012 2011	2012 2011 2011 29,236 31,908 30,879 Q1 Q4 Q1 2012 2011 2011	2012 2011 Change 29,236 31,908 30,879 -8.4% Q1 Q4 Q1 Sequential 2012 2011 2011 Change

Safe Harbor Notice:

This press release contains "forward-looking statements" within the meaning of Section 27A of the United States Securities Act of 1933, as amended, and Section 21E of the United States Securities Exchange Act of 1934, as amended, including statements regarding our future results of operations and business prospects. Although these forward-looking statements, which may include statements regarding our future results of operations, financial condition or business prospects, are based on our own information and information from other sources we believe to be reliable, you should not place undue reliance on these forward-looking statements, which apply only as of the date of this press release. The words "anticipate", "believe", "estimate", "expect", "intend", "plan" and similar expressions, as they relate to us, are intended to identify these forward-looking statements in this press release. Our actual results of operations, financial condition or business prospects may differ materially from those expressed or implied in these forward-looking statements for a variety of reasons, including risks associated with cyclicality and market conditions in the semiconductor industry; demand for the outsourced semiconductor packaging and testing services we offer and for such outsourced services generally; the highly competitive semiconductor industry; our ability to introduce new packaging, interconnect materials and testing technologies in order to remain competitive; our ability to successfully integrate pending and future mergers and acquisitions; international business activities; our business strategy; general economic and political conditions, including the recent global financial crisis; possible disruptions in commercial activities caused by natural or human-induced disasters; our future expansion plans and capital expenditures; the strained relationship between the Republic of China; fluctuations in foreign currency exchange rates; and other factors. For a discussion of these risks and other factors, please see th